

## FEATURES

- 2-axis light angle measurement**
- Linear response to the angle of incident light**
- Integrated visible light blocking optical filter**
- No optics required and no need for precise alignment**
- Low junction capacitance: 12.7 pF per channel at  $V_R = 0.2$  V**
- Low reverse dark current: 1.74 pA at  $V_R = 0.2$  V (all four channels connected in parallel)**
- 8-lead, 2 mm × 3 mm, 0.65 mm height, LFCSP**

## APPLICATIONS

- Gesture for user interface control in portable devices**
- Object location tracking**
- Industrial and automation monitoring**
- Angle sensing**
- Proximity sensing**
- Object distance measurement (triangulation)**

## GENERAL DESCRIPTION

The ADPD2140 is an optical sensor that measures the angle of incident infrared light. Light angles calculated from the ADPD2140 response are linear to  $\pm 5^\circ$  within an angular field of view of  $\pm 35^\circ$ .

The ADPD2140 has a radiant sensitive area of  $0.31 \text{ mm}^2$ . The low junction capacitance and low dark current of the ADPD2140 allows optimal integration with the [ADPD1080](#) photometric front end. The ADPD2140 can be used with a synchronous infrared light source such as a light emitting diode (LED) to

## FUNCTIONAL BLOCK DIAGRAM

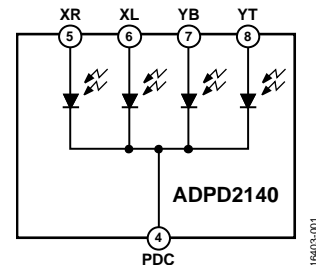


Figure 1.

detect user hand movements for gesture recognition. The ADPD2140 requires four photodiode channels. Therefore, use the [ADPD1080BCPZ](#) with the ADPD2140.

Packaged in a small, clear mold, 2 mm × 3 mm, 8-lead LFCSP, the ADPD2140 is specified over the  $-40^\circ\text{C}$  to  $+85^\circ\text{C}$  operating temperature range.

## TABLE OF CONTENTS

|   |   |   |    |
|---|---|---|----|
| Features .....                                    | 1 | Typical Performance Characteristics .....   | 6  |
| Applications .....                                | 1 | Theory of Operation .....                   | 7  |
| Functional Block Diagram .....                    | 1 | Angular Response .....                      | 7  |
| General Description .....                         | 1 | Typical Connection Diagram .....            | 7  |
| Revision History .....                            | 2 | Applications Information .....              | 8  |
| Specifications .....                              | 3 | Gesture Recognition .....                   | 8  |
| Absolute Maximum Ratings .....                    | 4 | Object Triangulation .....                  | 9  |
| Thermal Resistance .....                          | 4 | Evaluation Board Schematic and Layout ..... | 10 |
| Soldering Profile .....                           | 4 | Outline Dimensions .....                    | 12 |
| ESD Caution .....                                 | 4 | Ordering Guide .....                        | 12 |
| Pin Configuration and Function Descriptions ..... | 5 |   |    |

## REVISION HISTORY

8/2018—Revision 0: Initial Version

## SPECIFICATIONS

All specifications listed for the sum of all four photodiode channels, unless otherwise noted.

Table 1.

| Parameter                        | Symbol           | Test Conditions/Comments  | Min | Typ         | Max  | Unit             |
|----------------------------------|------------------|---|-----|-------------|------|------------------|
| <b>ELECTRICAL SPECIFICATIONS</b> |                  |   |     |             |      |                  |
| Forward Voltage                  | $V_F$            | Forward current ( $I_F$ ) = 10 mA                               |     | 0.75        |      | V                |
| Reverse Dark Current             | $I_D$            | Reverse voltage ( $V_R$ ) = 0.2 V,<br>$T_A = 20^\circ\text{C}$  |     | 1.74        |      | pA               |
| Junction Capacitance per Channel | $C_D$            | $V_R = 0.2$ V, frequency = 100 kHz                              |     | 12.7        |      | pF               |
| Rise Time                        | $t_r$            | Load resistance ( $R_L$ ) = 50 $\Omega$ ,<br>$\lambda = 880$ nm |     | 227         |      | ns               |
| Fall Time                        | $t_f$            | $R_L = 50$ $\Omega$ , $\lambda = 880$ nm                        |     | 228         |      | ns               |
| <b>OPTICAL SPECIFICATIONS</b>    |                  |   |     |             |      |                  |
| Radiant Sensitive Area           | $A_D$            |   |     | 0.31        |      | mm <sup>2</sup>  |
| Angle of Half Sensitivity        | $\varphi$        |   |     | $\pm 60$    |      | Degrees          |
| Wavelength of Peak Sensitivity   | $\lambda_P$      |   |     | 850         |      | nm               |
| Spectral Bandwidth               | $\lambda_{10\%}$ |   |     | 800 to 1080 |      | nm               |
| Spectral Responsivity            | $S_{880}$        | $\lambda = 880$ nm  |     | 0.43        |      | A/W              |
|                                  | $S_{940}$        | $\lambda = 940$ nm  |     | 0.32        |      | A/W              |
| Angular Slope                    | M                |   |     | 0.00631     |      | Ratio/ $^\circ$  |
| Angular Zero Crossing Offset     | Z                |   |     | $\pm 5$     |      | Degrees          |
| Angular Field of View            | FOV              | Linearity within $\pm 5^\circ$                                  |     | $\pm 35$    |      | Degrees          |
| <b>TEMPERATURE RANGE</b>         |                  |   |     |             |      |                  |
| Operating                        |                  |   | -40 |             | +85  | $^\circ\text{C}$ |
| Storage                          |                  |   | -40 |             | +125 | $^\circ\text{C}$ |

## ABSOLUTE MAXIMUM RATINGS

Table 2.

| Parameter                           | Rating |
|-------------------------------------|--------|
| Voltage (Any Channel)               |        |
| Forward                             | 1 V    |
| Reverse                             | 8 V    |
| Power Dissipation                   | 8 mW   |
| Junction Temperature                | 110°C  |
| Solder Reflow Temperature (<10 sec) | 260°C  |
| Electrostatic Discharge (ESD)       |        |
| Human Body Model (HBM)              | 2000 V |
| Charged Device Model (CDM)          | 1250 V |

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

### THERMAL RESISTANCE

Thermal performance is directly linked to printed circuit board (PCB) design and operating environment. Careful attention to PCB thermal design is required.

Table 3. Thermal Resistance<sup>1</sup>

| Package Type | $\theta_{JA}$ | $\theta_{JC}$ | Unit |
|--------------|---------------|---------------|------|
| CP-8-17      | 52.45         | 11.55         | °C/W |

<sup>1</sup> Test condition: the thermal impedance simulated values are based on a JEDEC 252P thermal test board with four thermal vias. See JEDEC JESD-51.

### SOLDERING PROFILE

Figure 2 and Table 4 provide details about the recommended soldering profile.

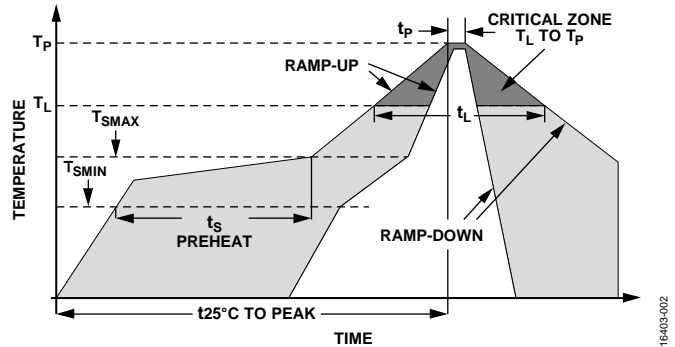


Figure 2. Recommended Soldering Profile

Table 4. Recommended Soldering Profile Limits<sup>1</sup>

| Profile Feature   | Condition (Pb Free) |
|---|---------------------|
| Average Ramp Rate ( $T_L$ to $T_P$ )                                  | 2°C/sec maximum     |
| Preheat   |                     |
| Minimum Temperature ( $T_{SMIN}$ )                                    | 150°C               |
| Maximum Temperature ( $T_{SMAX}$ )                                    | 200°C               |
| Time ( $T_{SMIN}$ to $T_{SMAX}$ ) ( $t_s$ )                           | 60 sec to 120 sec   |
| $T_{SMAX}$ to $T_L$ Ramp-Up Rate                                      | 2°C/sec maximum     |
| Liquidus Temperature ( $T_L$ )  | 217°C               |
| Time Maintained Above $T_L$ ( $t_L$ )                                 | 60 sec to 150 sec   |
| Peak Temperature ( $T_P$ )  | 260°C + (0°C/-5°C)  |
| Time Within 5°C of Actual Peak Temperature ( $t_p$ )                  | 20 sec to 30 sec    |
| Ramp Down Rate  | 3°C/sec maximum     |
| Time from 25°C to Peak Temperature ( $t_{25^\circ\text{C TO PEAK}}$ ) | 8 minutes maximum   |

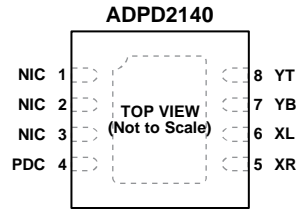
<sup>1</sup> Based on JEDEC Standard J-STD-020D.1.

### ESD CAUTION



**ESD (electrostatic discharge) sensitive device.** Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

# PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



- NOTES**  
 1. NIC = NOT INTERNALLY CONNECTED.  
 2. EXPOSED PAD. ALWAYS CONNECT THE EXPOSED PAD TO PDC. DO NOT CONNECT THE EXPOSED PAD TO GROUND UNLESS PDC IS ALSO CONNECTED TO GROUND.

16r403-003

Figure 3. Pin Configuration

Table 5. Pin Function Descriptions

| Pin No. | Mnemonic | Type                     | Description  |
|---------|----------|--------------------------|--|
| 1       | NIC      | Not internally connected | Not Internally Connected. Leave this pin floating.   |
| 2       | NIC      | Not internally connected | Not Internally Connected. Leave this pin floating.   |
| 3       | NIC      | Not internally connected | Not Internally Connected. Leave this pin floating.   |
| 4       | PDC      | Analog input             | Photodiode Common Cathode (PDC).   |
| 5       | XR       | Analog output            | Photodiode XR Anode.   |
| 6       | XL       | Analog output            | Photodiode XL Anode.   |
| 7       | YB       | Analog output            | Photodiode YB Anode.   |
| 8       | YT       | Analog output            | Photodiode YT Anode.   |
|         | EPAD     | Not applicable           | Exposed Pad. Always connect the exposed pad to PDC. Do not connect the exposed pad to ground unless PDC is also connected to ground. |

# TYPICAL PERFORMANCE CHARACTERISTICS

All performance characteristics listed for the sum of all four photodiode channels, unless otherwise noted.

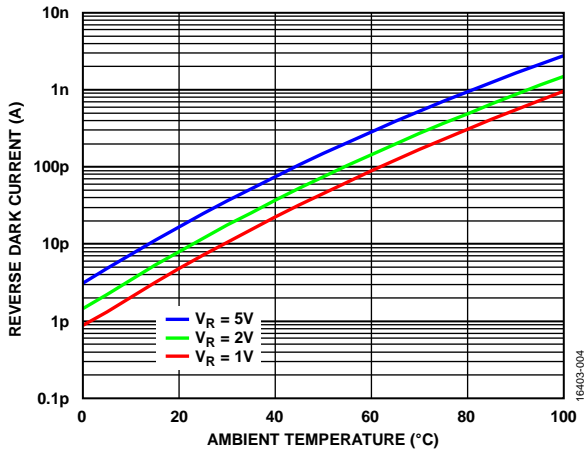


Figure 4. Reverse Dark Current vs. Ambient Temperature over Reverse Voltage ( $V_R$ )

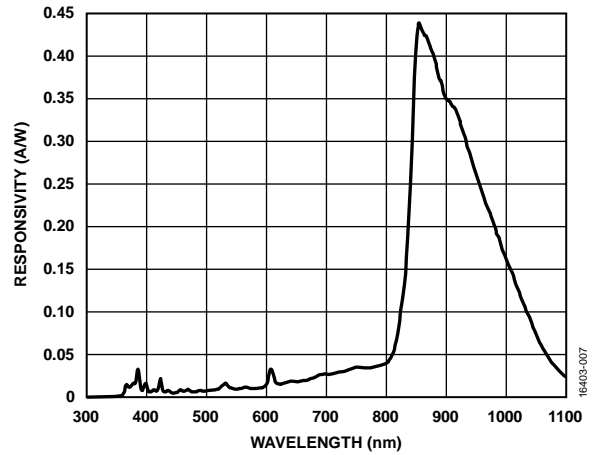


Figure 7. Responsivity vs. Wavelength (Angle = 0°)

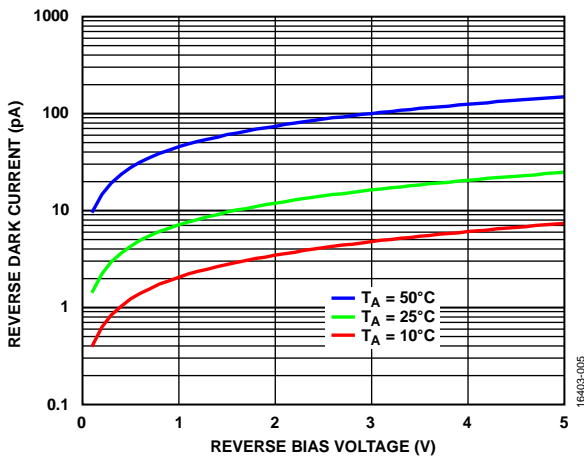


Figure 5. Reverse Dark Current vs. Reverse Bias Voltage over Temperature

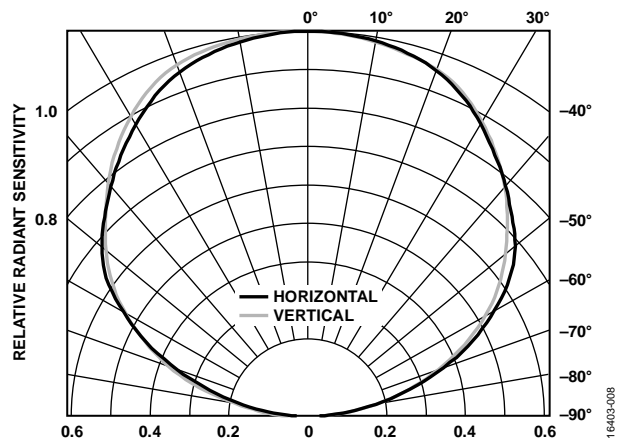


Figure 8. Relative Radiant Sensitivity vs. Angular Displacement

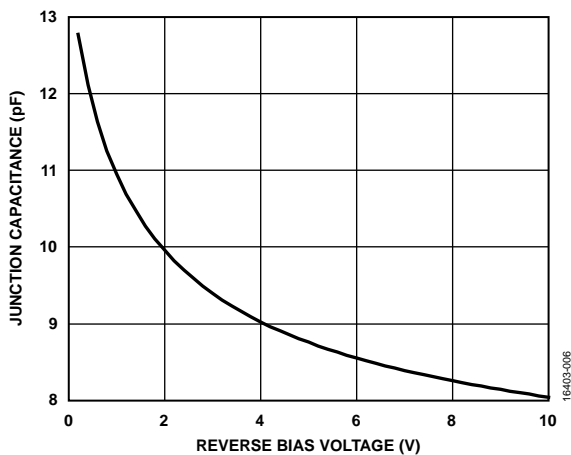


Figure 6. Junction Capacitance vs. Reverse Bias Voltage (per Channel)

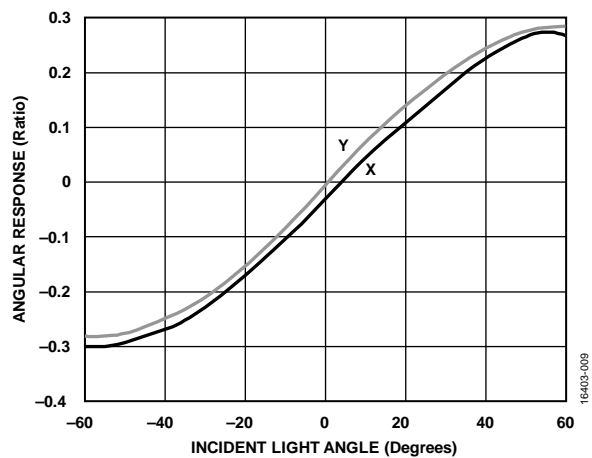


Figure 9. Angular Response vs. Incident Light Angle

# THEORY OF OPERATION

## ANGULAR RESPONSE

The ADPD2140 consists of arrays of silicon p-type, intrinsic, n-type (PIN) photodiodes that provide a linear measurement of incident infrared light angle. There are four separate channels on the ADPD2140, each corresponding to one photodiode.

The ADPD2140 enables a 2-axis light angle measurement, in both the x and y direction. To calculate angles in the x and y direction with respect to the sensor use the four photodiode channels ( $x_L$ ,  $x_R$ ,  $y_T$ , and  $y_B$ ) and the following equations:

$$x = (x_L - x_R) / (x_L + x_R) \tag{1}$$

$$y = (y_T - y_B) / (y_T + y_B) \tag{2}$$

The resulting quantities (x and y) are ratios related to angles through a constant term, M. Calculate angles in the horizontal and vertical direction by dividing x and y by the constant term, M (see Table 1). Angles measured by the ADPD2140 are linear to  $\pm 5^\circ$  within an angular field of view of  $\pm 35^\circ$  and zero crossing offset at  $\pm 5^\circ$ , as seen in Figure 9. The directionality when using Equation 1 and Equation 2 is shown in Figure 10, which indicates positive angles in the x and y directions.

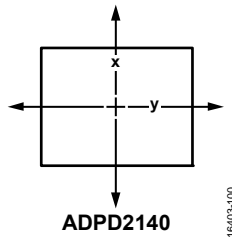


Figure 10. Directionality Response

The ADPD2140 is typically used in conjunction with a LED or laser emitter operating at a near infrared wavelength. The ADPD2140 provides light angle measurement without the need for an external lens. An external lens is neither required nor recommended for operation.

An integrated visible light blocking optical filter on the ADPD2140 provides built in rejection of unwanted visible ambient light signals, such as sunlight and indoor lighting. Figure 7 shows the combined responsivity of the ADPD2140 with the integrated optical filter.

The low junction capacitance and low dark current of the ADPD2140 allows optimal integration with the ADPD1080 photometric front end. This complete solution offers additional ambient light rejection, low power operation, and analog-to-digital conversion of the ADPD2140 analog signals.

## TYPICAL CONNECTION DIAGRAM

Figure 11 shows the ADPD2140 connections with the ADPD1080 photometric front end. With up to eight photodiode input channels, the ADPD1080 is a preferred choice for the analog front end for interfacing with the ADPD2140. In this configuration, the ADPD2140 and ADPD1080 solution can operate using synchronous LED pulses to detect the angle of light reflected from objects or used in ambient measurement mode to provide a measure of the incident angle of an ambient or other unsynchronized light source. For reference, the optimal choice of reverse bias for typical operation with the ADPD2140 is 0.2 V.

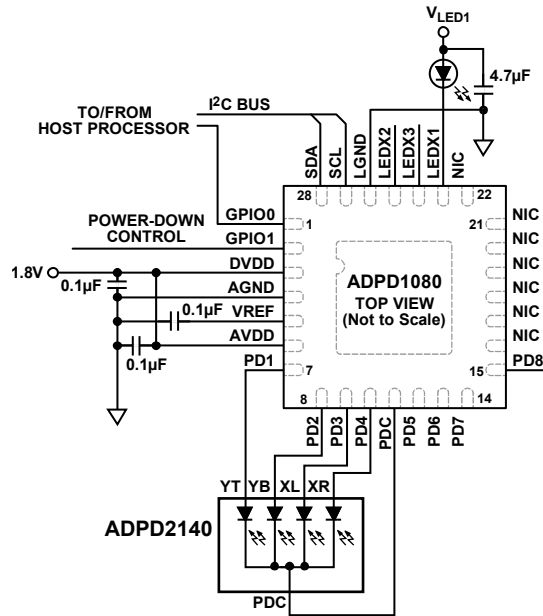


Figure 11. Typical Connection Diagram for the ADPD2140 and the ADPD1080

## APPLICATIONS INFORMATION

### GESTURE RECOGNITION

The unique angular response of the ADPD2140 coupled with the high performance ambient light rejection of the [ADPD1080](#) enables a robust and effective implementation of gesture recognition. The following algorithm demonstrates recognition of up, down, left, right, and click hand gestures based on data from the four channels of the ADPD2140:

1. Prior to operation of the ADPD2140 and the [ADPD1080](#) for gesture recognition, calibrate the [ADPD1080](#) clocks. See the [ADPD1080](#) data sheet for more information on how to calibrate the 32 kHz and 32 MHz clocks.
2. Set the [ADPD1080](#) mode of operation to sample mode by writing 0x2 to Register 0x10, Bits [1:0].
3. Collect the data measured by the device. See the [ADPD1080](#) data sheet for instructions on how to read data from registers using the first in, first out (FIFO) and interrupts. Data is available directly from data registers or from the 128-byte FIFO in Register 0x60, Bits [15:0].
4. The data in the four output channels of the [ADPD1080](#) calculates the angle of incident light. After the  $x_L$ ,  $x_R$ ,  $y_T$ , and  $y_B$  data are collected, calculate the angles and intensity with the following equations:
  - Horizontal angle:  $x = (x_L - x_R)/(x_L + x_R)$
  - Vertical angle:  $y = (y_T - y_B)/(y_T + y_B)$
  - Intensity:  $L = x_L + x_R + y_T + y_B$
5. Prior to gesture event detection, offsets of the [ADPD1080](#) must be digitally subtracted from each channel. These offsets are not due to photodiode dark current and are set by the [ADPD1080](#) on-chip analog-to-digital converter (ADC). Register 0x18, Register 0x19, Register 0x1A, and Register 0x1B contain the ADC offsets for Timeslot A, while Register 0x1A, Register 0x1B, Register 0x1E, and Register 0x1F contain the ADC offsets for Timeslot B. The nominal value for all offsets is 0x2000. To modify these offsets, measure the 16-bit output of each channel, in ADC codes, and add it to the existing 16-bit number in the ADC offset register, SLOTx\_CHx\_OFFSET (nominally 0x2000). Then, write to the ADC offset register with this result. When the offsets are correctly subtracted, the intensity reading L is close to zero codes with no objects in the sensor field of view.
6. The start of a gesture event can be defined as occurring when intensity data crosses a preset threshold. Nominally, this threshold must be set to 1000 codes. However, the threshold can be adjusted to suit the application.
7. The end of a gesture event can then be defined as the number of samples after which the intensity drops back below the preset threshold, past a certain minimum number of samples (nominally five samples).

8. Use the start and stop points of the gesture event to determine whether the gesture was up, right, left, down, or a click. For more detail on this process, see the following pseudocode:

```

event = False
intensityThreshold = 1000 (should be
adjustable by the user)
clickThreshold = 0.07 (should be adjustable
by the user)

if event = True:
    i += 1
    if i >= 5 and L < intensityThreshold:
        event = False
        gestureStopX = x
gestureStopY = y
m = (gestureStartY -
gestureStopY)/(gestureStartX - gestureStopX
+ 1e-6)
d = sqrt((gestureStartX - gestureStopX)^2 +
(gestureStartY - gestureStopY)^2)
if d < clickThreshold:
    gesture = 'CLICK'
else:
    if abs(m) > 1:
        if gestureStartY >
gestureStopY:
            gesture = 'UP'
        else:
            gesture = 'DOWN'
    elif abs(m) < 1:
        if gestureStartX >
gestureStopX:
            gesture = 'LEFT'
        else:
            gesture = 'RIGHT'
    else:
        if L > intensityThreshold:
            i = 0
            event = True
            gestureStartX = x
gestureStartY = y

```



### OBJECT TRIANGULATION

While a single ADPD2140 allows for measurement of the x and y coordinates of an object or light source, two ADPD2140 placed at a distance apart can calculate the z distance using triangulation. The superscripted A and B refer to ADPD2140 sensors that are measured in Timeslot A and Timeslot B of the ADPD2140. Calculate the triangulation distance z as follows:

If  $\text{sign}(y^A) = \text{sign}(y^B)$ ,

$$z = \frac{C}{\sqrt{(y^A - y^B)^2}}$$

Or, if  $\text{sign}(y^A) \neq \text{sign}(y^B)$ ,

$$z = \frac{C}{\sqrt{(y^A + y^B)^2}}$$

C is an empirically determined proportionality constant that depends on the baseline distance between the two angle diodes, which converts the x and y measurements to angles, in radians. For reference, the baseline distance, c, between both angle diodes is equal to 1" on the [EVAL-ADPD2140Z](#) evaluation board. This quantity sets the units of the final distance measurement output.

Figure 12 shows the operation of a typical triangulation measurement using the ADPD2140.

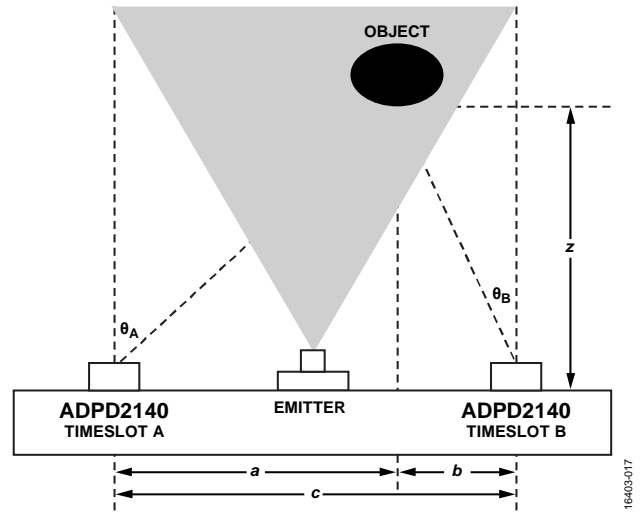


Figure 12. Triangulation Distance Measurement with the ADPD2140

16403-017

EVALUATION BOARD SCHEMATIC AND LAYOUT

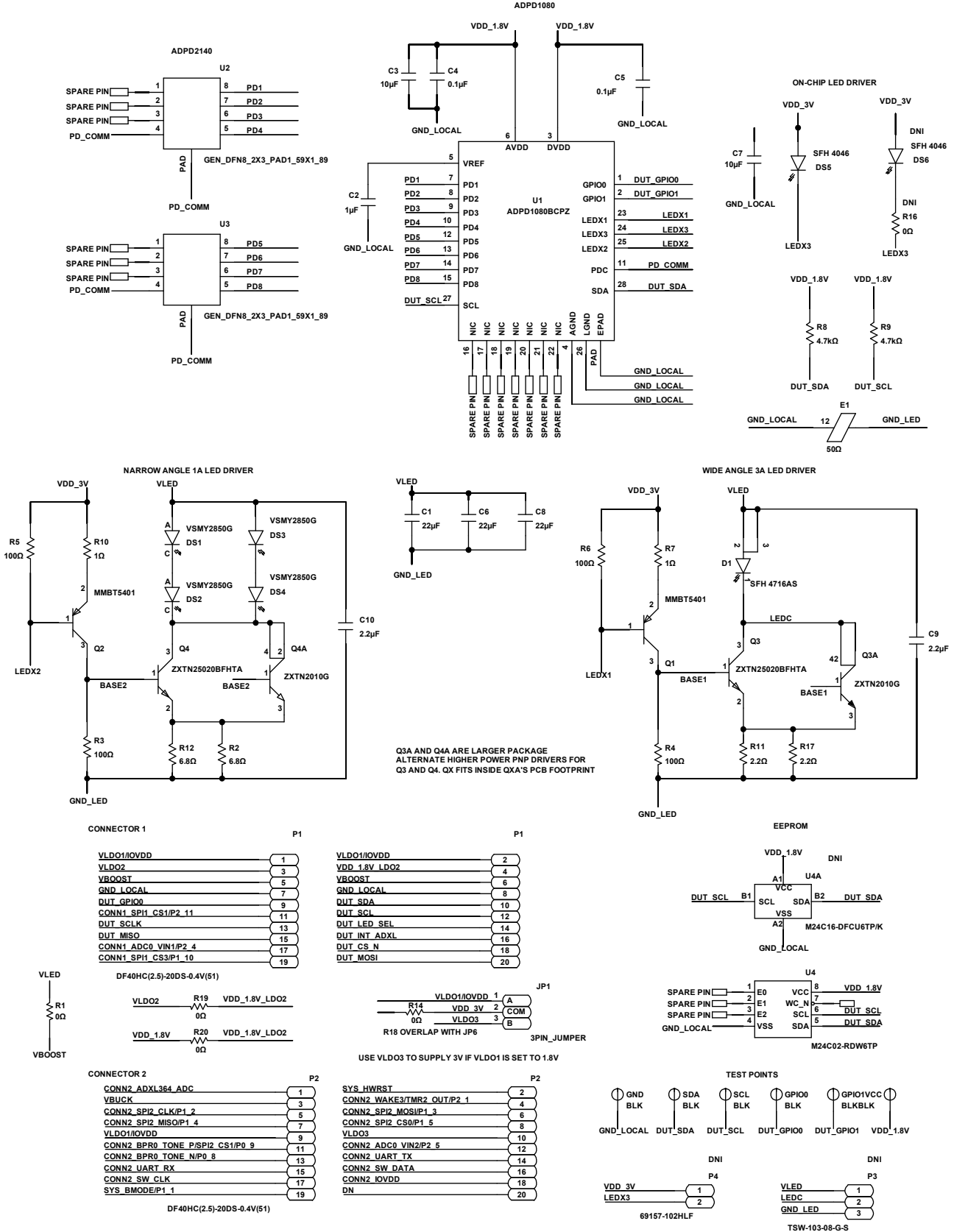


Figure 13. EVAL-ADPD2140Z Evaluation Board Schematic

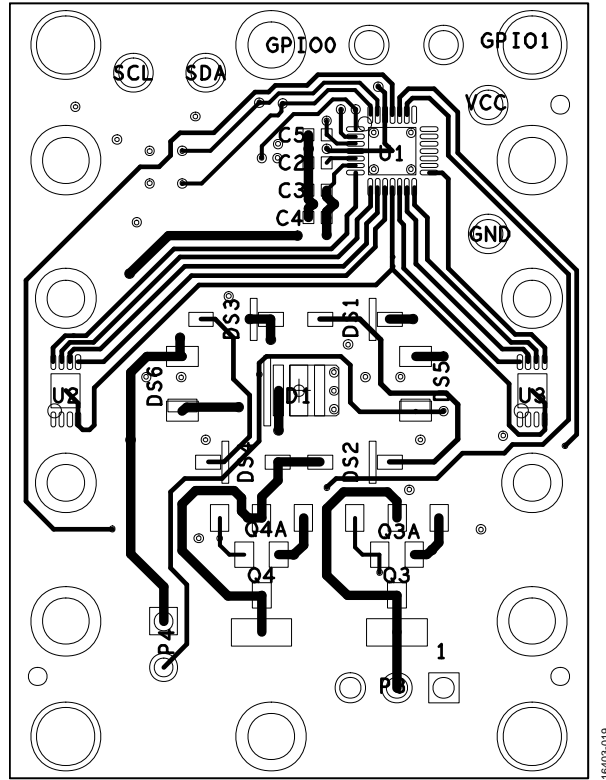


Figure 14. EVAL-ADPD2140Z Evaluation Board Layout

18403-019

## OUTLINE DIMENSIONS

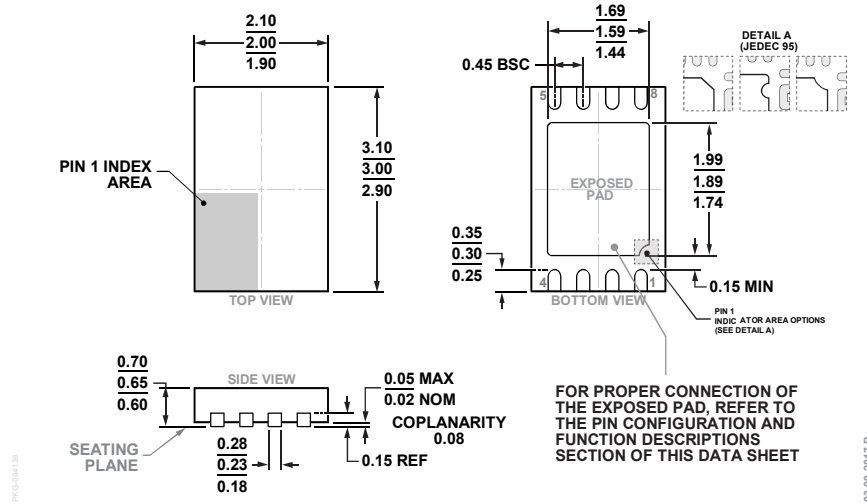


Figure 15. 8-Lead Lead Frame Chip Scale Package [LFCSP]  
2 mm x 3 mm Body and 0.65 mm Package Height  
(CP-8-17)  
Dimensions shown in millimeters

## ORDERING GUIDE

| Model <sup>1</sup> | Temperature Range | Package Description                          | Package Option |
|--------------------|-------------------|--|----------------|
| ADPD2140BCPZN-R7   | -40°C to +85°C    | 8-Lead Lead Frame Chip Scale Package [LFCSP] | CP-8-17        |
| ADPD2140BCPZN-RL   | -40°C to +85°C    | 8-Lead Lead Frame Chip Scale Package [LFCSP] | CP-8-17        |
| EVAL-ADPD2140Z     |                   | ADPD2140 Evaluation Board                    |                |

<sup>1</sup> Z = RoHS Compliant Part.

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкуренспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)  
Email: [org@lifeelectronics.ru](mailto:org@lifeelectronics.ru)